



东莞市铭标电子科技有限公司
MINGBIAO ELECTRONICS CO., LTD

承 认 书

APPROVE SHEET

客户名称 Customer: _____

品 名 Part name: Tact switch

型 号 Part Number: THBM05

Design/ Date	Check/ Date	Review/ Date	Approval/ Date

贵公司承认印 Approval signatures

Approval/ Date	Remark

Send us a copy of reference , thank you! 日期 Date:

地址: 广东省东莞市长安镇沙头社区猫山东路 101 号

Add:DongguanCity, GuangdongProvince, Chang' an Town, Sand head community The cat shandong road, No. 101

Ntel:0769-81581583

	SPECIFICATION		Page 1/6
	Version A/0		
MODEL	THBM05	Date	2018.05.15

1、 概述

GENERAL

1.1 适用范围

APPLICATION

此规格书适用于机械式轻触开关的相关要求

This specification is applied to the requirements for TACTILE SWITCH (MECHANICAL CONTACT)

1.2 工作温度范围

Operating Temperature Range

-20℃~70℃ (在标准大气压、标准湿度条件下)

-20℃~70℃ (Normal humidity, normal air pressure)

1.3 贮藏温度范围

Storage Temperature Range

-30℃~80℃ (在标准大气压、标准湿度条件下)

-30℃~80℃ (Normal humidity, normal air pressure)

1.4 测试条件

Test Conditions

在没有其它特定的条件下，应该在以下的条件下进行测试和测量：

Unless otherwise specified, tests and measurement shall be made in the following standard conditions:

常温.....5℃~35℃

Normal temperature.....5℃~35℃

标准湿度.....相对湿度25%~85%

Normal humidity.....relative humidity 25%~85%

标准大气压.....86KPa~106Kpa

Normal air pressure.....86Kpa~106Kpa

在制造过程中，测试和测量应该在以下的条件下进行：

If any doubt arise from the judgment, tests shall be conducted at the following conditions:

温度.....20℃±2℃

Temperature.....20℃±2℃

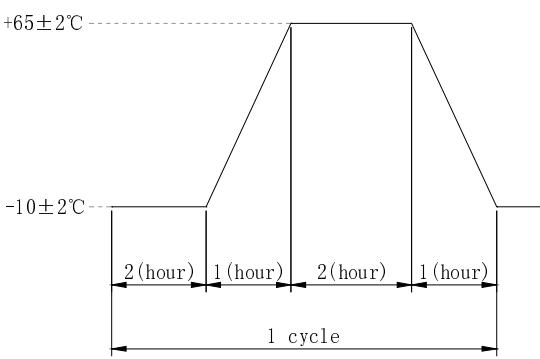
相对湿度.....65%±5%

Relative humidity.....65%±5%

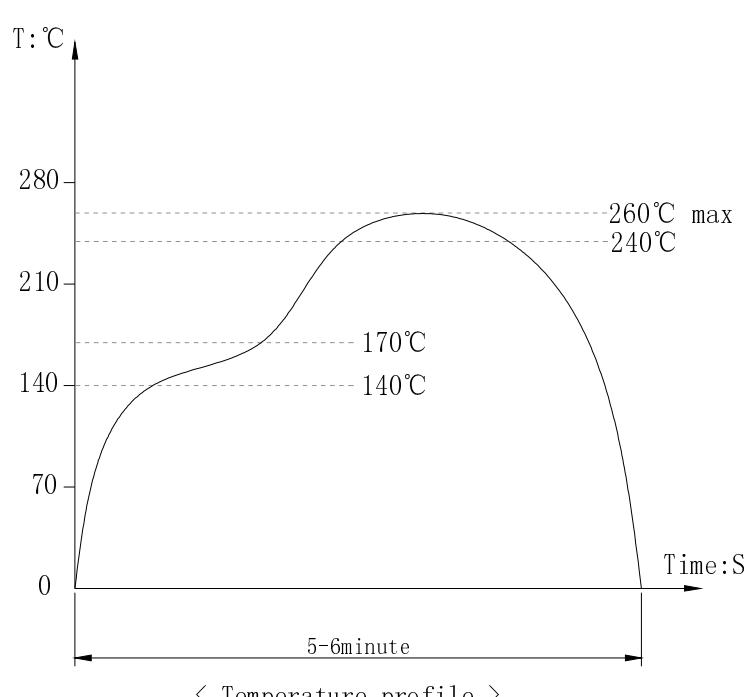
环境气压.....86KPa~106Kpa

Air pressure.....86KPa~106Kpa

		SPECIFICATION		Page	3/6
				Version	A/0
	MODEL	THBM05		Date	2018.05.15
NO.	项目 ITEM	试验条件 TEST CONDITIONS		要求 REQUIREMENTS	
4.2	最大行程 Full Travel	开关垂直于操作方向放置，以一个等于2倍按力的静负荷施加在开关驱动件顶端中心，测量顶端移动的距离。 Placing the switch such that the direction of switch operation is vertical and then applying static load of 2times operating force to the center of the stem; the travel distance for the switch to come to a stop shall be measured.		0.15±0.1mm	
4.3	回弹力 Return Force	开关垂直于操作方向放置，在开关驱动件顶端中心下降至全行程后，测量顶端向自由位置转换的力度。 The sample switch is installed such that the direction of switch operation is vertical and upon depressing the stem in its center to the whole travel distance, the force of the stem to return to its free position shall be measured.		回弹力 Return Force: 50gf min	
4.4	停止强度 Stop Strength	开关垂直于操作方向放置，从操作方向向驱动件施加20N的静负荷持续1min。 Placing the switch such that the direction of switch operation is vertical, and then a static load of 20N shall be applied in the direction of stem operation for a period of 1 min.		无机械和电气损坏 There shall be no sign of damage mechanically and electrically.	
4.5	可焊性 Solderability	在以下设定条件下进行测量： Measurements shall be made following the test set forth below: (1) 焊接温度: 245±5°C Solder temperature : 245±5°C (2) 浸入时间: 2s±0.5s Immersion time: 2s±0.5s 对于其它步骤参考《GB 5095.6—86》试验12a The other steps please refer to 《GB 5095.6—86》 TEST 12a		除边缘外涂层应均匀覆盖90%以上 Except for the edge, the coating should cover a minimum 90%	
5、极限电气性能: ENVIRONMENTAL SPECIFICATION					
5.1	低温测试 Resistance to low temperature	样品应按照以下实验条件进行测试，实验后样品应放在常温及标准湿度的环境中1小时后做性能测试： Following the test set forth below the sample shall be left in normal temperature and humidity conditions for 1 h before measurements are made: (1) 温度: -30±2°C Temperature : -30±2°C (2) 时间: 48h Time: 48h		接触电阻: ≤200mΩ Contact resistance: ≤200mΩ 项目3, 4.1, 4.2, 4.3 Item 3, 4.1, 4.2, 4.3	

		SPECIFICATION		Page	4/6
		Version	A/0		
NO.	项目 ITEM	MODEL	THBM05	Date	2018. 05. 15
5. 2	高温测试 Heat resistance	样品应按照以下实验条件进行测试，实验后样品应放在常温及标准湿度的环境中1小时后做性能测试：Following the test set forth below the sample shall be left in normal temperature and humidity conditions for 1 h before measurements are made: (1) 温度：80±2°C temperature:80±2°C (2) 时间：48h time: 48h			
5. 3	湿温测试 Moisture resistance	样品应按照以下实验条件进行测试，实验后样品应放在常温及标准湿度的环境中1小时后做性能测试：Following the test set forth below the sample shall be left in normal temperature and humidity conditions for 1 h before measurements are made: (1) 温度：60±2°C temperature: 60±2°C (2) 相对湿度：90%~95% relative humidity:90% to 95% (3) 时间：48h time: 48h	接触电阻： $\leq 200\text{m}\Omega$ Contact resistance: $\leq 200\text{m}\Omega$ 项目3, 4. 1, 4. 2, 4. 3 Item 3, 4. 1, 4. 2, 4. 3		
5. 4	温度周期性测试 Change of temperature	根据下面的测试要求进行5次循环的温度周期性测试，实验后样品应放在常温及标准湿度的环境中1小时后做性能测试。测试期间样品应保持干燥。 After 5 cycles of following conditions, the sample shall be allowed to stand under normal temperature and humidity conditions for 1 h. and measurements shall be made. During the test water drops shall be removed. 			

		SPECIFICATION		Page	5/6
				Version	A/0
	MODEL	THBM05	Date	2018. 05. 15	
5. 5	硫化试验 Sulfuration resistance	<p>样品应按照以下实验条件进行测试，实验后样品用清水冲洗后进行测试：Samples should be tested in accordance with the following experimental conditions. After the experiment, samples should be washed with clean water and tested:</p> <ul style="list-style-type: none"> (1) 硫化钾浓度: 2% K2S concentration: 2% (2) 常温浸泡时间: 1分钟 Soaking time at room temperature: 1 minute 	<p>金属件无明显腐蚀、氧化 No obvious corrosion and oxidation of metal parts</p>		
5. 6	盐雾试验 Salt Mist	<p>在以下设定条件下进行测量： The switch shall be checked after following test:</p> <ul style="list-style-type: none"> (1) 温度: 35°C±2°C temperature: 35°C±2°C (2) 盐溶液浓度: 5±1% (质量百分比) salt solution : 5±1%(solids by mass) (3) 时间: 24h±1h Time: 24h±1 hour <p>实验后的盐沉积物后水冲掉 After test, salt deposit shall be removed by running water.</p>	<p>金属件上没有腐蚀斑点 No remarkable corrosion shall be recognized in metal part.</p>		
<p>6、 极限机械性能: ENDURANCE SPECIFICATION</p>					
6. 1	工作寿命 Operation life	<p>根据下面的测试要求进行测试： Measurement shall be made following the test set forth below:</p> <ul style="list-style-type: none"> (1) DC 12V, 50mA带负载 DC 12V, 50 mA resistive load (2) 按动速率: 2次/秒 Rate of operation: 2 times/s (3) 按力: 200g Operating Force: 200g (4) 平均无故障寿命/Average fault-free life: 100000次 	<p>接触电阻≤500mΩ Contact resistance≤500mΩ 触点弹力≤10ms Contact bounce≤10ms 按力: 初值的±30% Operating Force: initial value±30% 项目3, 4. 1, 4. 2, 4. 3 Item 3, 4. 1, 4. 2, 4. 3</p>		
<p>7、 焊接条件: SOLDERING CONDITIONS:</p>					
7. 1	手工焊接 Hand soldering	<p>请按以下条件进行焊接：</p> <ul style="list-style-type: none"> (1) 焊锡温度: ≤350°C (2) 连续焊接时间: ≤3 s <p>Please practice according to below conditions:</p> <ul style="list-style-type: none"> (1) Soldering temperature: 350°C Max. (2) Continuous soldering time: 3 s Max. 			

		SPECIFICATION		
		Page	6/6	
		Version	A/0	
MODEL	THBM05	Date	2018. 05. 15	
7.2	自动焊接 Automatic soldering	<p>在使用的情况下自动焊接 In case the automatic flow soldering is to be used</p> <p>(1) 预热 ----- 150°C ~ 175°C, 40 ~ 80 sec Preheat ----- 150°C ~ 175°C, 40 ~ 80 sec</p> <p>(2) 峰值温度----- 260°C (max) Peak temperature ----- 260°C (max)</p> <p>(3) 焊接区温度----- 260°C, 1 ~ 4 sec, 2 times (max) Soldering area temperature ----- 260°C, 1 ~ 4 sec, 2 times (max)</p> <p>(4) 高温后性能衰变值±20% After high temperature, the decay data about performance will be ±20%</p> <p style="text-align: center;">T: °C</p> 		
<p>8、 Other precautions 其他注意事项</p> <p>8.1 印刷基板的安装孔尺寸参见产品图。 Follow recommended P.W.B. piercing plan in outside drawing page.</p> <p>8.2 注意不要施加超负荷的压力或晃动开关。 Please be cautious not to give excessive static load or shock to switches.</p> <p>8.3 进行焊接过程中，不可以用溶剂或类似品清洗开关。 Following the soldering process, do not try to clean the switch with a solvent or the like.</p> <p>8.4 防止助焊剂从开关的顶端渗入。 Safeguard the switch assembly against flux penetration from its topside.</p> <p>8.5 保管时尤其应注意避开高湿高温和有腐蚀性气体的环境。如需要长时间保存，请不要打开包装箱。 Preservation under high temperature and high humidity or corrosive gas should be avoided Especially. When you need to preserve for a long period, do not open the carton.</p>				